## DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

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• •	·8	declare that: my residence		s and citizenship are as	s stated below nex
As a below named invent my name; that I verily believe nt inventor (if plural inventors a titled:					
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ie:				<u> </u>	
which is described and claimed the attached specification, o	d in:				
) the specification in the appli	ication Serial I	110	filed	;	
and with amendments through the specification in Internation on June 5, 2003	onal Application	(if applicable on No. PCT/ <u>JP02/0966</u> e).		eptember 20, 20	02 and as amende
hereby state that I have review any amendment(s) referred t	ved and under o above.	rstand the content of the a	above-identified spec	cification, including the	claims, as amende
acknowledge my duty to discle efined in Title 37, Code of Fe	ose to the Pat deral Regulation	tent and Trademark Office ons, §1.56.	all information kno	wn to me to be materi	al to patentability a
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And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from AOYAMA & PARTNERS

the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to Customer No:

000513

Direct Telephone Calls to:

WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021

Phone:(202) 721-8200 Fax:(202) 721-8250

$^{\prime}\mathcal{W}$	
Full Name of First Inventor	FAMILY NAME FIRST GIVEN NAME SECOND GIVEN NAME SAKAI Kazunobu
Residence &	CITY STATE OR COUNTRY COUNTRY OF CITIZENSHIP
Citizenship	Nakakoma-gun, Yamanashi, Japan Japan
Post Office	ADDRESS CITY STATE OR COUNTRY ZIP CODE
Address	2-8-202, Wakamiya, Tamaho-cho, Nakakoma-gun, Yamanashi 409-3803 Japan

Full Name of	FAMILY NAME	FIRST GIVEN NAME	SECOND GIVEN NAME
Second Inventor	NAKASHIMA	Makoto	
Residence & Citizenship	Kofu-shi, Yamanashi		ountry of citizenship apan
Post Office Address	ADDRESS 11-46, Aoba-cho, Kofu-s		r country zip code )828 Japan

Full Name of Third Inventor	FAMILY NAME HIRAI	first given name Wataru	SECOND GIVEN NAME	
Residence & Citizenship	Nakakoma-gun,	STATE OR COUNTRY Yamanashi, Japan	COUNTRY OF CITIZENSHIP  Japan	- 1
Post Office Address	ADDRESS 544-1-203, Saijo Japan		rate or country zip code n-gun, Yamanashi 409–3866	

Full Name of	FAMILY NAME	FIRST GIVEN NAME	SECOND GIVEN NAME
Fourth Inventor	ISHITANI	Yasuyuki	
Residence &	CITY	STATE OR COUNTRY	COUNTRY OF CITIZENSHIP
Citizenship	Nakakoma-gun	, Yamanashi, Japan	Japan
Post Office	ADDRESS	CITY ST.	ATE OR COUNTRY ZIP CODE
Address	2466-III202, Ka 409-3861 Japan	amisukiawara, Showa-cho	, Nakakoma-gun, Yamanashi

Full Name of Fifth Inventor	PAMILY NAME		FIRST GIVEN NAME	SECOND GI	VEN NAME
Residence & Citizenship	CITY		STATE OR COUNTRY	COUNTRY OF C	ITIZENSHIP
Post Office Address	ADDRESS		CITY	STATE OR COUNTRY	ZIP CODE
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